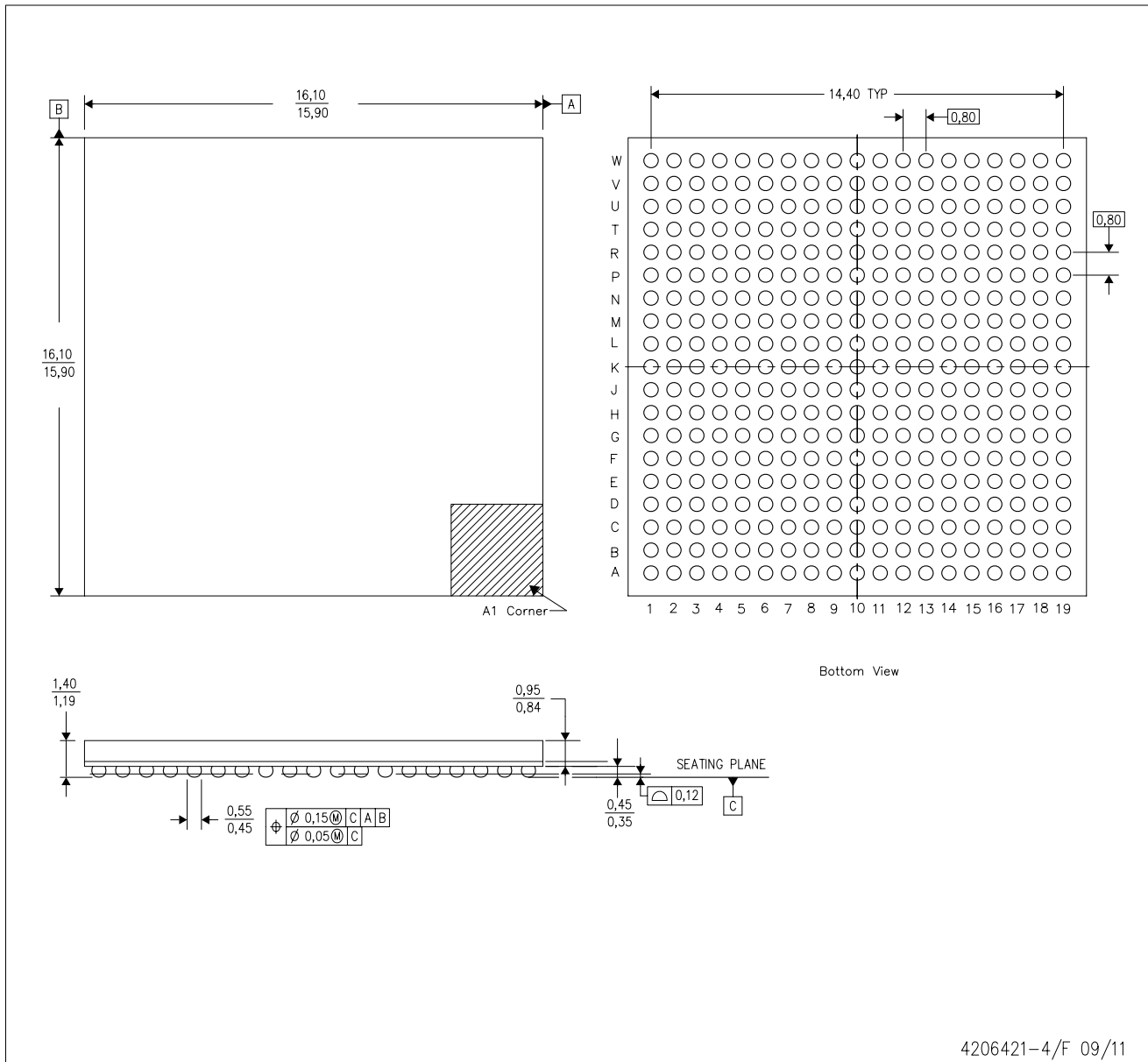


ZWT (S-PBGA-N361)

PLASTIC BALL GRID ARRAY



4206421-4/F 09/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. This is a Pb-free solder ball design.
  - D. Falls within JEDEC MO-275.

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